WO 2004/093222 PCT/US2004/010882

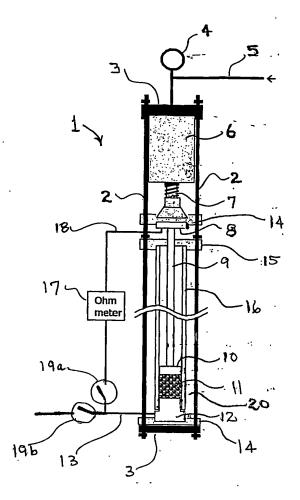
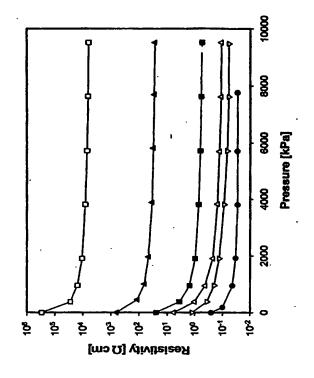
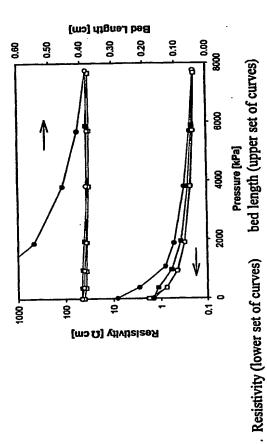


FIG. 1

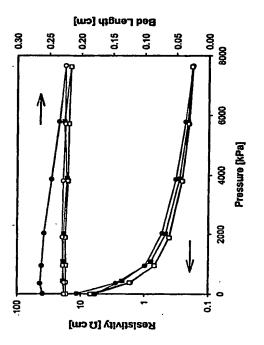


· (

□: 650°C, ▲: 750°C, ■: 850°C, △: 950°C, ♡: 1050°C, ●



●: pressurization #1, O: depressurization #1, ■: pressurization #2, □: depressurization #2.

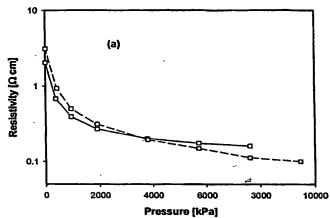


Resistivity (lower set of curves) bed length (upper set of curves)

i. pressurization #1, O: depressurization #1, ■: pressurization #2, □: depressurization #2

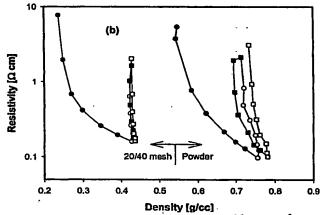
F1G. 4





Solid line: 20/40 mesh. Dashed line: powder. Each curve shows depressurization #2.

Fig. 5b



Left side: 20/40 mesh. Right side: powder.

•: pressurization #1, O:depressurization #1,

■: pressurization #2, □: depressurization #2.